

Errata

- Publication II: The growth and dissolution rates of iron precipitates in the thin heavily doped boron layer are multiplied by the product of the iron segregation coefficient $k_{seg}(B)$ and the effective diffusion constant of iron $D(B)$ normalized to the bulk diffusion constant.
- Publication III: The growth and dissolution rates of iron precipitates in the thin heavily doped boron layer are multiplied by the product of the iron segregation coefficient $k_{seg}(B)$ and the effective diffusion constant of iron $D(B)$ normalized to the bulk diffusion constant.
- Publication V: The first processing step in Table 1 should be: Ion implantation mask oxide growth for 50 min at 1050 °C to 435 nm thickness and high temperature annealing for oxygen outdiffusion for 310 min at 1100 °C
- The sixth processing step in Table 1 should be: Oxidation for 180 min at 1000 °C and high temperature annealing for phosphorus drive-in and oxide precipitate growth for 1080 min at 1100 °C
- The ninth processing step in Table 1 should be: Field oxide growth for 70 min at 1000 °C to 380 nm thickness